

SNVS765C-JUNE 1999-REVISED APRIL 2013

LM723/LM723C Voltage Regulator

Check for Samples: LM723, LM723C

FEATURES

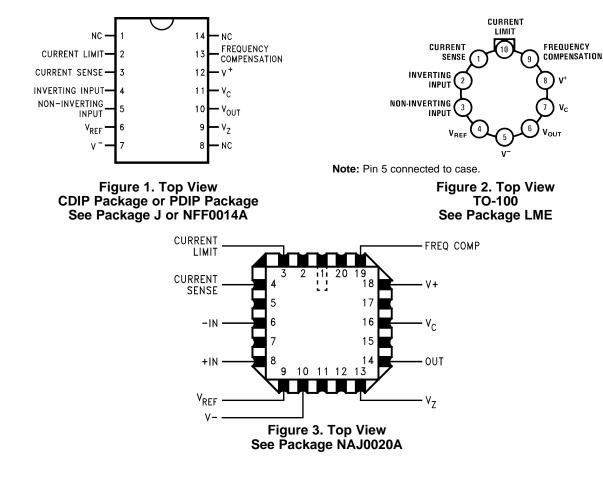
- 150 mA Output Current Without External Pass
 Transistor
- Output Currents in Excess of 10A Possible by Adding External Transistors
- Input Voltage 40V Max
- Output Voltage Adjustable from 2V to 37V
- Can be Used as Either a Linear or a Switching Regulator

DESCRIPTION

The LM723/LM723C is a voltage regulator designed primarily for series regulator applications. By itself, it will supply output currents up to 150 mA; but external transistors can be added to provide any desired load current. The circuit features extremely low standby current drain, and provision is made for either linear or foldback current limiting.

The LM723/LM723C is also useful in a wide range of other applications such as a shunt regulator, a current regulator or a temperature controller.

The LM723C is identical to the LM723 except that the LM723C has its performance ensured over a 0°C to $+70^{\circ}$ C temperature range, instead of -55° C to $+125^{\circ}$ C.



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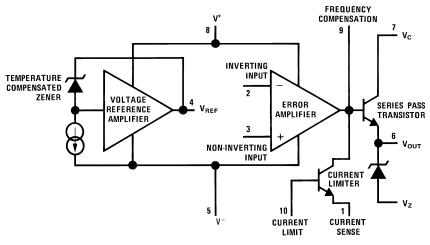
Connection Diagram



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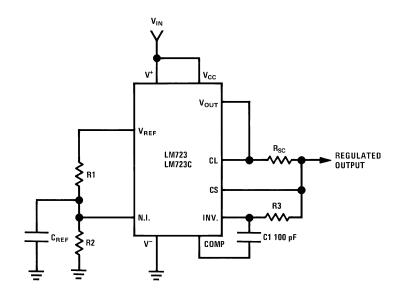
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Equivalent Circuit*



*Pin numbers refer to metal can package.

Typical Application



Note: R3 = $\frac{R1 R2}{R1 + R2}$ for minimum temperature drift.

Regulated Output Voltage	5V
Line Regulation ($\Delta V_{IN} = 3V$)	0.5mV
Load Regulation ($\Delta I_L = 50 \text{ mA}$)	1.5mV



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾⁽²⁾

Pulse Voltage from V ⁺ to V ⁻ (50 ms)	50V
Continuous Voltage from V ⁺ to V ⁻	40V
Input-Output Voltage Differential	40V
Maximum Amplifier Input Voltage (Either Input)	8.5V
Maximum Amplifier Input Voltage (Differential)	5V
Current from V _Z	25 mA
Current from V _{REF}	15 mA
Internal Power Dissipation Metal Can ⁽³⁾	800 mW
CDIP (3)	900 mW
PDIP ⁽³⁾	660 mW
Operating Temperature Range	
LM723	−55°C to +150°C
LM723C	0°C to +70°C
Storage Temperature Range Metal Can	−65°C to +150°C
PDIP	−55°C to +150°C
Lead Temperature (Soldering, 4 sec. max.)	
Hermetic Package	300°C
Plastic Package	260°C
ESD Tolerance	1200V
(Human body model, 1.5 k Ω in series with 100 pF)	

(1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits.

(2) A military RETS specification is available on request. At the time of printing, the LM723 RETS specification complied with the Min and Max limits in this table. The LM723E, H, and J may also be procured as a Standard Military Drawing.

(3) See derating curves for maximum power rating above 25°C.

ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾

Parameter	Conditions	LM723				Units		
		Min	Тур	Max	Min	Тур	Max	
Line Regulation	$V_{IN} = 12V$ to $V_{IN} = 15V$		0.01	0.1		0.01	0.1	% V _{OUT}
	-55°C ≤ T _A ≤ +125°C			0.3				% V _{OUT}
	$0^{\circ}C \le T_{A} \le +70^{\circ}C$						0.3	% V _{OUT}
	$V_{IN} = 12V$ to $V_{IN} = 40V$		0.02	0.2		0.1	0.5	% V _{OUT}
Load Regulation	$I_L = 1 \text{ mA to } I_L = 50 \text{ mA}$		0.03	0.15		0.03	0.2	% V _{OUT}
	-55°C ≤ T _A ≤ +125°C			0.6				% V _{OUT}
	$0^{\circ}C \le T_{A} \le +70^{\circ}C$						0.6	% V _{OUT}
Ripple Rejection	$f = 50 \text{ Hz to } 10 \text{ kHz}, \text{ C}_{\text{REF}} = 0$		74			74		dB
	f = 50 Hz to 10 kHz, C_{REF} = 5 μ F		86			86		dB

(1) Unless otherwise specified, $T_A = 25^{\circ}C$, $V_{IN} = V^+ = V_C = 12V$, $V^- = 0$, $V_{OUT} = 5V$, $I_L = 1$ mA, $R_{SC} = 0$, $C_1 = 100$ pF, $C_{REF} = 0$ and divider impedance as seen by error amplifier $\leq 10 \text{ k}\Omega$ connected as shown in Figure 4. Line and load regulation specifications are given for the condition of constant chip temperature. Temperature drifts must be taken into account separately for high dissipation conditions.

(2) A military RETS specification is available on request. At the time of printing, the LM723 RETS specification complied with the Min and

Max limits in this table. The LM723E, H, and J may also be procured as a Standard Military Drawing.

(3) Specified by correlation to other tests.

(4) L₁ is 40 turns of No. 20 enameled copper wire wound on Ferroxcube P36/22-3B7 pot core or equivalent with 0.009 in. air gap.

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ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾ (continued)

Parameter	Conditions		LM723	;		Units		
		Min	Тур	Max	Min	Тур	Max	
Average Temperature Coefficient of Output Voltage (⁽⁵⁾)	-55°C ≤ T _A ≤ +125°C		0.002	0.015				%/°C
	$0^{\circ}C \leq T_{A} \leq +70^{\circ}C$					0.003	0.015	%/°C
Short Circuit Current Limit	$R_{SC} = 10\Omega, V_{OUT} = 0$		65			65		mA
Reference Voltage		6.95	7.15	7.35	6.80	7.15	7.50	V
Output Noise Voltage	BW = 100 Hz to 10 kHz, $C_{REF} = 0$		86			86		µVrms
	BW = 100 Hz to 10 kHz, C_{REF} = 5 μ F		2.5			2.5		µVrms
Long Term Stability			0.05			0.05		%/1000 hrs
Standby Current Drain	$I_{L} = 0, V_{IN} = 30V$		1.7	3.5		1.7	4.0	mA
Input Voltage Range		9.5		40	9.5		40	V
Output Voltage Range		2.0		37	2.0		37	V
Input-Output Voltage Differential		3.0		38	3.0		38	V
θ _{JA}	PDIP					105		°C/W
θ _{JA}	CDIP		150					°C/W
θ _{JA}	H10C Board Mount in Still Air		165			165		°C/W
θ _{JA}	H10C Board Mount in 400 LF/Min Air Flow		66			66		°C/W
θ _{JC}			22			22		°C/W

(5) For metal can applications where V_Z is required, an external 6.2V zener diode should be connected in series with V_{OUT} .



0.05

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T_A = -55°C

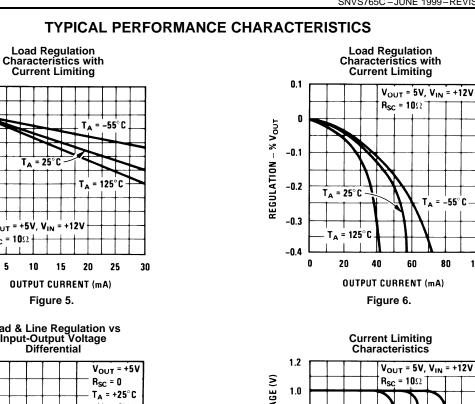
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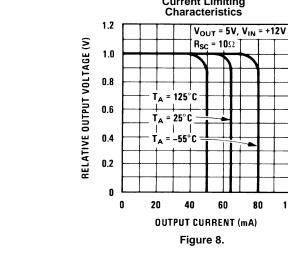
100

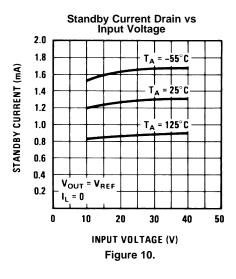
100

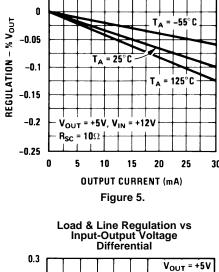
80

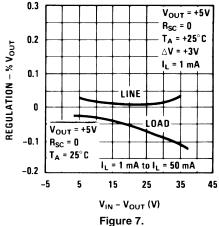
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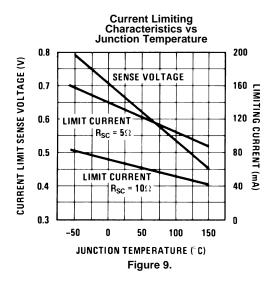








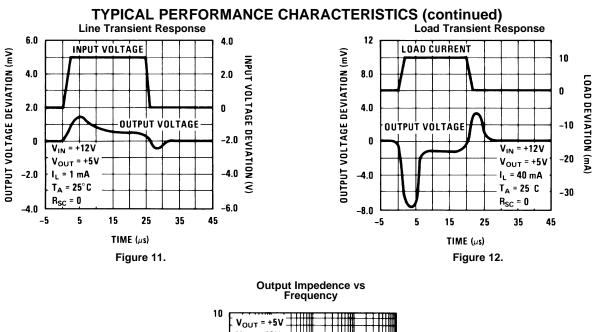




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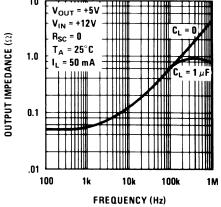
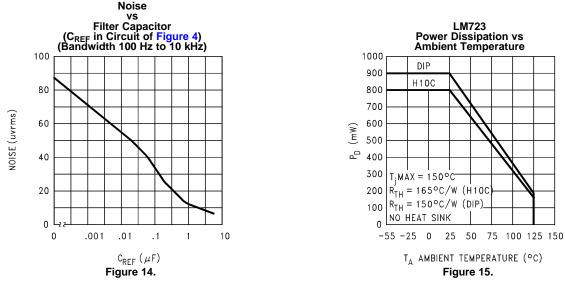


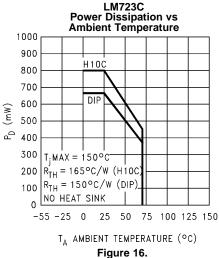
Figure 13.



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MAXIMUM POWER RATINGS







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Table 1. Resistor Values ($k\Omega$) for Standard Output Voltage																																															
Positive Output	Applicable Figures		ked ut ±5%	Ad	Output Adjustable ±10% ⁽¹⁾		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Adjustable		Negative Output	Applicable Figures		ked ut ±5%		% Out djusta ±10%	able
Voltage	See ⁽²⁾	R1	R2	R1	P1	R2	Voltage		R1	R2	R1	P1	R2																																		
+3.0	Figure 4, Figure 19, Figure 21, Figure 24, Figure 27 (Figure 19)	4.12	3.01	1.8	0.5	1.2	+100	Figure 22	3.57	102	2.2	10	91																																		
+3.6	Figure 4, Figure 19, Figure 21, Figure 24, Figure 27 (Figure 19)	3.57	3.65	1.5	0.5	1.5	+250	Figure 22	3.57	255	2.2	10	240																																		
+5.0	Figure 4, Figure 19, Figure 21, Figure 24, Figure 27 (Figure 19)	2.15	4.99	0.75	0.5	2.2	-6 ⁽³⁾	Figure 18, (Figure 25)	3.57	2.43	1.2	0.5	0.75																																		
+6.0	Figure 4, Figure 19, Figure 21, Figure 24, Figure 27 (Figure 19)	1.15	6.04	0.5	0.5	2.7	-9	Figure 18, Figure 25	3.48	5.36	1.2	0.5	2.0																																		
+9.0	Figure 17, Figure 19, (Figure 19, Figure 21, Figure 24, Figure 27)	1.87	7.15	0.75	1.0	2.7	-12	Figure 18, Figure 25	3.57	8.45	1.2	0.5	3.3																																		
+12	Figure 17, Figure 19, (Figure 19, Figure 21, Figure 24, Figure 27)	4.87	7.15	2.0	1.0	3.0	-15	Figure 18, Figure 25	3.65	11.5	1.2	0.5	4.3																																		
+15	Figure 17, Figure 19, (Figure 19, Figure 21, Figure 24, Figure 27)	7.87	7.15	3.3	1.0	3.0	-28	Figure 18, Figure 25	3.57	24.3	1.2	0.5	10																																		
+28	Figure 17, Figure 19, (Figure 19, Figure 21, Figure 24, Figure 27)	21.0	7.15	5.6	1.0	2.0	-45	Figure 23	3.57	41.2	2.2	10	33																																		
+45	Figure 22	3.57	48.7	2.2	10	39	-100	Figure 23	3.57	97.6	2.2	10	91																																		
+75	Figure 22	3.57	78.7	2.2	10	68	-250	Figure 23	3.57	249	2.2	10	240																																		

(1)

Replace R1/R2 in figures with divider shown in Figure 28. Figures in parentheses may be used if R1/R2 divider is placed on opposite input of error amp. V⁺ and V_{CC} must be connected to a +3V or greater supply.

(2) (3)

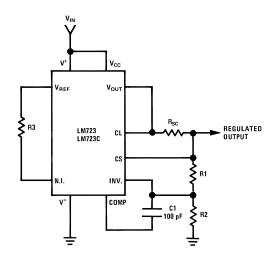
Outputs from +2 to +7 volts	Outputs from +4 to +250 volts	Current Limiting
(Figure 4 Figure 19 Figure 20 Figure 21 Figure 24 Figure 27	(Figure 22)	
$V_{OUT} = \left(V_{REF} \times \frac{R2}{R1 + R2}\right)$	$V_{OUT} = \left(rac{V_{REF}}{2} imes rac{R2 - R1}{R1} ight); R3 = R4$	$I_{\text{LIMIT}} = \frac{V_{\text{SENSE}}}{R_{\text{SC}}}$
Outputs from +7 to +37 volts	Outputs from −6 to −250 volts	Foldback Current Limiting
(Figure 17 Figure 19 Figure 20 Figure 21 Figure 24 Figure 27)	(Figure 18 Figure 23 Figure 25)	$I_{\text{KNEE}} = \left(\frac{V_{\text{OUT}} \text{ R3}}{\text{R}_{\text{SC}} \text{ R4}} + \frac{V_{\text{SENSE}} (\text{R3} + \text{R4})}{\text{R}_{\text{SC}} \text{ R4}}\right)$
$V_{OUT} = \left(V_{REF} \times \frac{R1 + R2}{R2}\right)$	$V_{OUT} = \left(\frac{V_{REF}}{2} \times \frac{R1 + R2}{R1}\right); R3 = R4$	$I_{\text{SHORT CKT}} = \left(\frac{V_{\text{SENSE}}}{R_{\text{SC}}} \times \frac{R3 + R4}{R4}\right)$

Table 1, Resistor Values (kQ) for Standard Output Voltage



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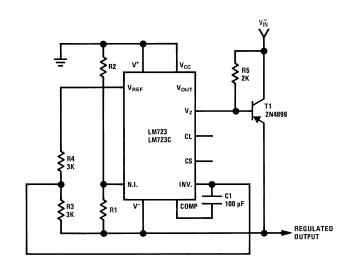
TYPICAL APPLICATIONS



Note: $R3 = \frac{R1R2}{R1 + R2}$ for minimum temperature drift. R3 may be eliminated for minimum component count.

	Typical Performance
Regulated Output Voltage	15V
Line Regulation ($\Delta V_{IN} = 3V$)	1.5 mV
Load Regulation ($\Delta I_L = 50 \text{ mA}$)	4.5 mV

Figure 17. Basic High Voltage Regulator (V_{OUT} = 7 to 37 Volts)



Typical Performance

Regulated Output Voltage Line Regulation ($\Delta V_{IN} = 3V$) Load Regulation ($\Delta I_L = 100$ mA)



-15V

1 mV

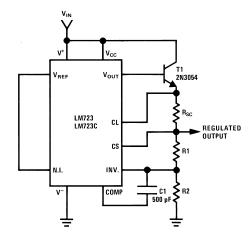
2 mV

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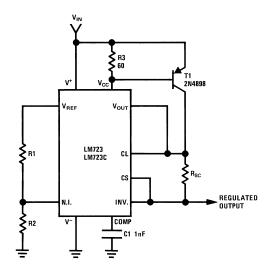


Typical Performance

Regulated Output Voltage Line Regulation ($\Delta V_{IN} = 3V$) Load Regulation ($\Delta I_L = 1A$) +15V 1.5 mV

15 mV





Regulated Output Voltage	+5V
Line Regulation ($\Delta V_{IN} = 3V$)	0.5 mV
Load Regulation ($\Delta I_L = 1A$)	5 mV



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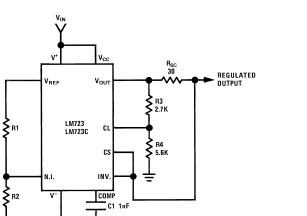


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+5V 0.5 mV

1 mV

20 mA

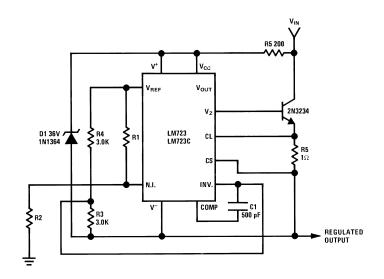


Typical Performance

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Regulated Output Voltage Line Regulation ($\Delta V_{IN} = 3V$) Load Regulation ($\Delta I_L = 10 \text{ mA}$) Short Circuit Current





Regulated Output Voltage	+50V
Line Regulation ($\Delta V_{IN} = 20V$)	15 mV
Load Regulation ($\Delta I_L = 50 \text{ mA}$)	20 mV



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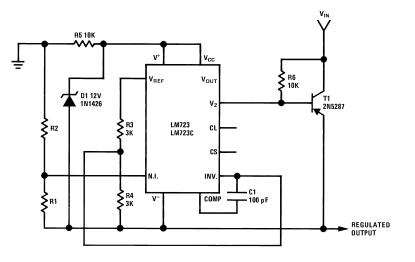


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-100V

30 mV

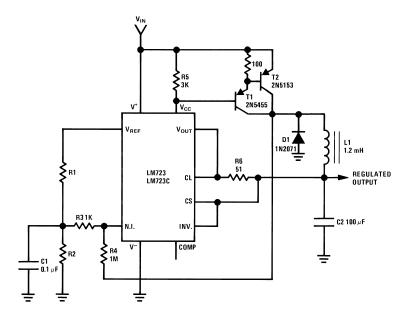
20 mV



Typical Performance

Regulated Output Voltage Line Regulation ($\Delta V_{IN} = 20V$) Load Regulation ($\Delta I_L = 100$ mA)



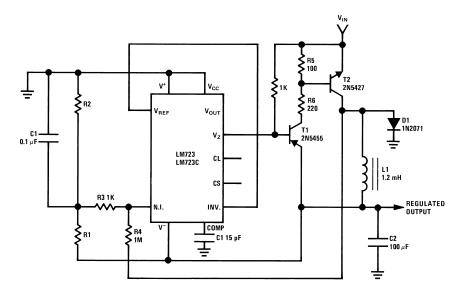


Regulated Output Voltage	+5V
Line Regulation ($\Delta V_{IN} = 30V$)	10 mV
Load Regulation ($\Delta I_L = 2A$)	80 mV





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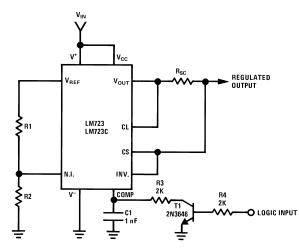
Typical Performance

Regulated Output Voltage Line Regulation ($\Delta V_{IN} = 20V$) Load Regulation ($\Delta I_L = 2A$)

-1	5V

- 8 mV
- 6 mV

Figure 25. Negative Switching Regulator



Note: Current limit transistor may be used for shutdown if current limiting is not required.

Typical Performance

Regulated Output Voltage	+5V
Line Regulation ($\Delta V_{IN} = 3V$)	0.5 mV
Load Regulation ($\Delta I_L = 50 \text{ mA}$)	1.5 mV

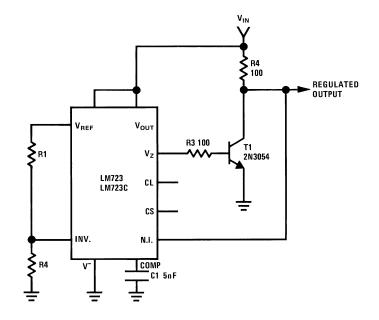
Figure 26. Remote Shutdown Regulator with Current Limiting

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Regulated Output Voltage+5VLine Regulation ($\Delta V_{IN} = 10V$)0.5 mVLoad Regulation ($\Delta I_L = 100 \text{ mA}$)1.5 mV

Figure 27. Shunt Regulator

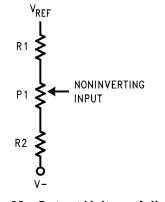


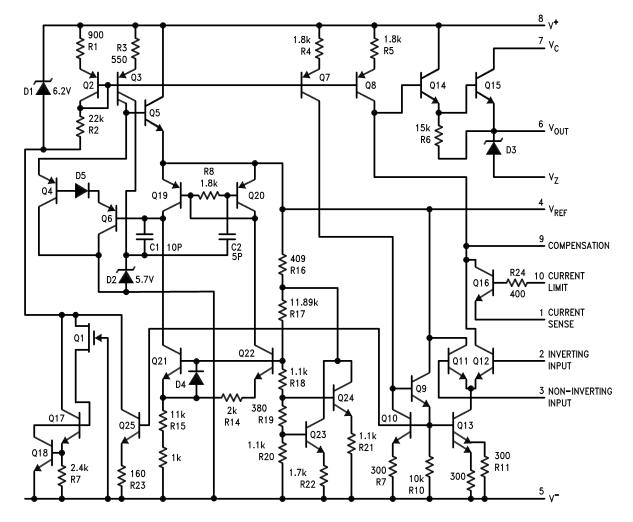
Figure 28. Output Voltage Adjust ⁽¹⁾

(1) Replace R1/R2 in figures with divider shown in Figure 28.



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Schematic Diagram



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REVISION HISTORY

Cł	nanges from Revision B (April 2013) to Revision C F	Page
•	Changed layout of National Data Sheet to TI format	15

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	•	Pins	•	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LM723CH	ACTIVE	TO-100	LME	10	500	TBD	Call TI	Call TI	0 to 70	(LM723CH ~ LM723CH)	Samples
LM723CH/NOPB	ACTIVE	TO-100	LME	10	500	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	0 to 70	(LM723CH ~ LM723CH)	Samples
LM723CN/NOPB	ACTIVE	PDIP	NFF	14	25	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	0 to 70	LM723CN	Samples
LM723H	ACTIVE	TO-100	LME	10	500	TBD	Call TI	Call TI	-55 to 150	(LM723H ~ LM723H)	Samples
LM723H/NOPB	ACTIVE	TO-100	LME	10	500	Green (RoHS & no Sb/Br)	Call TI	Level-1-NA-UNLIM	-55 to 150	(LM723H ~ LM723H)	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



27-Jul-2016

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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GENERIC PACKAGE VIEW

TO-CAN - 5.72 mm max height METAL CYLINDRICAL PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



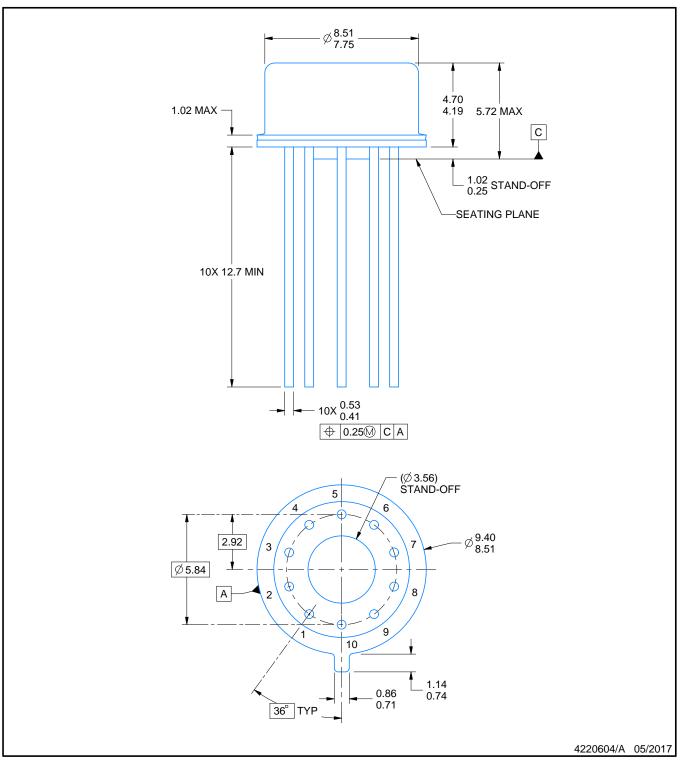
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PACKAGE OUTLINE

TO-CAN - 5.72 mm max height

METAL CYLINDRICAL PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.2. This drawing is subject to change without notice.3. Reference JEDEC registration MO-006/TO-100.

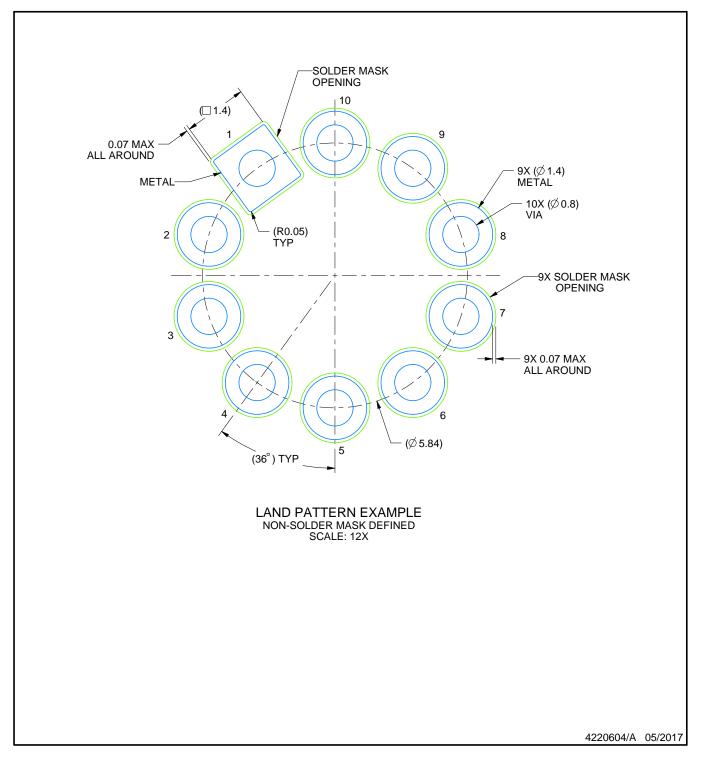


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EXAMPLE BOARD LAYOUT

TO-CAN - 5.72 mm max height

METAL CYLINDRICAL PACKAGE





MECHANICAL DATA

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